- Contains Eight Flip-Flops With Single-Rail Outputs
- Buffered Clock and Direct Clear Inputs
- Individual Data Input to Each Flip-Flop
- Applications Include:

Buffer/Storage Registers Shift Registers Pattern Generators

description

These monolithic, positive-edge-triggered flipflops utilize TTL circuitry to implement D-type flip-flop logic with a direct clear input.

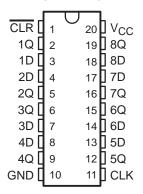
Information at the D inputs meeting the setup time requirements is transferred to the Q outputs on the positive-going edge of the clock pulse. Clock triggering occurs at a particular voltage level and is not directly related to the transition time of the positive-going pulse. When the clock input is at either the high or low level, the D input signal has no effect ar the output.

These flip-flops are guaranteed to respond to clock frequencies ranging form 0 to 30 megahertz while maximum clock frequency is typically 40 megahertz. Typical power dissipation is 39 milliwatts per flip-flop for the '273 and 10 milliwatts for the 'LS273.

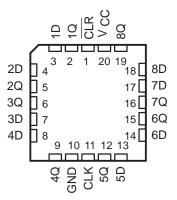
FUNCTION TABLE (each flip-flop)

ı	NPUTS		OUTPUT
CLEAR	CLOCK	Q	
L	Χ	Χ	L
н	\uparrow	Н	Н
н	\uparrow	L	L
Н	L	Χ	Q ₀

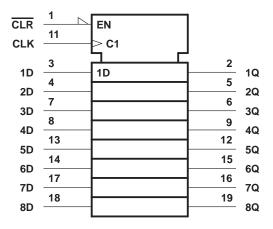
SN54273, SN74LS273 . . . J OR W PACKAGE SN74273 . . . N PACKAGE SN74LS273 . . . DW OR N PACKAGE (TOP VIEW)



SN54LS273 . . . FK PACKAGE (TOP VIEW)



logic symbol†

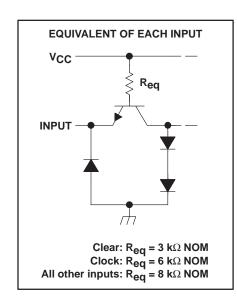


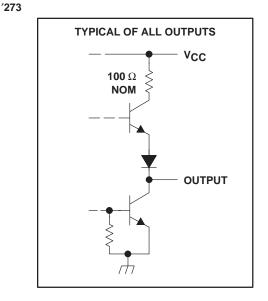
[†]This symbol is in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12.

Pin numbers shown are for the DW, J, N, and W packages.



schematics of inputs and outputs



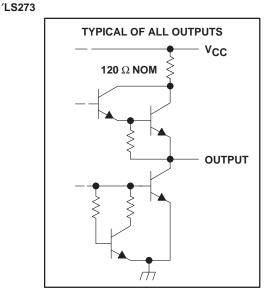


EQUIVALENT OF EACH INPUT

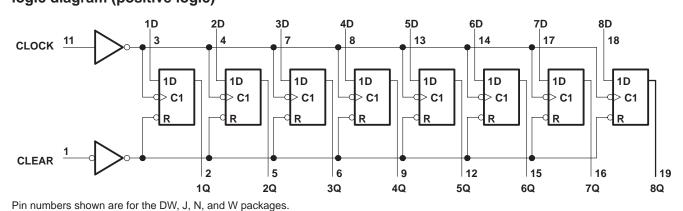
VCC

20 kΩ
NOM

INPUT



logic diagram (positive logic)





absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V _{CC} (see Note 1)	7 V
Input voltage	5.5 V
Operating free-air temperature range, T _A : SN54273	-55°C to 125°C
SN74273	0°C to 70°C
Storage temperature range	-65°C to 150°C

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

			SN54273		SN74273			UNIT	
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT	
Supply voltage, V _{CC}		4.5	5	5.5	4.75	5	5.25	V	
High-level output current, IOH				-800			-800	μΑ	
Low-level output current, I _{OL}				16			16	mA	
Clock frequency, f _{clock}				30	0		30	MHz	
Width of clock or clear pulse, t _W		16.5			16.5			ns	
Sotup time +	Data input	20↑			20↑			20	
Setup time, t _{SU}	Clear inactive state	25↑			25↑			ns	
Data hold time, th					5↑			ns	
Operating free-air temperature, TA		-55		125	0		70	°C	

[↑]The arrow indicates that the rising edge of the clock pulse is used for reference.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	PARAMETER		TEST C	ONDITIONS†	MIN	TYP‡	MAX	UNIT	
V _{IH}	High-level input voltage				2			V	
VIL	Low-level input voltage						0.8	V	
٧ıK	Input clamp voltage		V _{CC} = MIN,	$I_{I} = -12 \text{ mA}$			-1.5	V	
Vон			V _{CC} = MIN, V _{IL} = 0.8 V,	$V_{IH} = 2 V$, $I_{OH} = -800 \mu A$	2.4	3.4		V	
VOL	Low-level output voltage		V _{CC} = MIN, V _{IL} = 0.8 V,	$V_{IH} = 2 V$, $I_{OH} = 16 \text{ mA}$			0.4	V	
Ιį	Input current at maximum input voltag	је	V _{CC} = MAX,	V _I = 5.5 V			1	mA	
l	High-level input current	Clear	VMAY	V _I = 2.4 V			80		
liH	nigh-level input current	Clock or D	V _{CC} = MAX,	V = 2.4 V			40	μΑ	
1	Low-level input current	Clear	VCC = MAX,	V _I = 0.4 V			-3.2	mA	
ΊL	Low-level input current	Clock or D	VCC = WAX,	V = 0.4 V			-1.6	111/4	
los	Short-circuit output current§		V _{CC} = MAX		-18		-57	mA	
Icc			V _{CC} = MAX,	See Note 2		62	94	mA	

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

NOTE 2: With all outputs open and 4.5 V applied to all data and clear inputs, I_{CC} is measured after a momentary ground, then 4.5 V, is applied to clock.



 $^{^\}ddagger$ All typical values are at V_{CC} = 5 V, T_A = 25°C.

[§] Not more than one output should be shorted at a time.

SN54273, SN54LS273, SN74273, SN74LS273 OCTAL D-TYPE FLIP-FLOP WITH CLEAR

SDLS090 - OCTOBER 1976 - REVISED MARCH 1988

switching characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
fmax	Maximum clock frequency		30	40		MHz
tPHL	Propagation delay time, high-to-low-level output from clear	C _L = 15 pF,		18	27	ns
^t PLH	Propagation delay time, low-to-high-level output from clock	R _L = 400 Ω , See Note 3		17	27	ns
tPHL	Propagation delay time, high-to-low-level output from clock			18	27	ns

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V _{CC} (see Note 1)	7 V
Input voltage	7 V
Operating free-air temperature range, TA: SN54LS273	–55°C to 125°C
SN74LS273	0°C to 70°C
Storage temperature range	65°C to 150°C

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

		SI	N54LS27	'3	SN74LS273			UNIT		
		MIN	NOM	MAX	MIN	NOM	MAX	UNII		
Supply voltage, V _{CC}		4.5	5	5.5	4.75	5	5.25	V		
High-level output current, IOH				-400			-400	μΑ		
Low-level output current, IOL			4			8	mA			
Clock frequency, f _{clock}	0		30	0		30	MHz			
Width of clock or clear pulse, tw		20			20			ns		
Cotup time t	Data input	20↑			20↑					
Setup time, t _{SU}	Clear inactive state	25↑			25↑			ns		
Data hold time, th		5↑			5↑			ns		
Operating free-air temperature, TA		-55		125	0		70	°C		

The arrow indicates that the rising edge of the clock pulse is used for reference.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	PARAMETER	TEC	T CONDITION	uet	SI	N54LS27	'3	SI	N74LS27	'3	UNIT
	PARAMETER	153	TEST CONDITIONS!			TYP‡	MAX	MIN	TYP‡	MAX	UNII
VIH	High-level input voltage				2			2			V
VIL	Low-level input voltage						0.7			0.8	V
VIK	Input clamp voltage	V _{CC} = MIN,	I _I = -18 mA				-1.5			-1.5	V
Vон	High-level output voltage	V _{CC} = MIN, V _{IL} = V _{IL} max,	$V_{IH} = 2 V,$ $I_{OH} = -400$	μΑ	2.5	3.4		2.7	3.4		V
\/o:	Low-level output voltage	V _{CC} = MIN,	V _{IH} = 2 V,	$I_{OL} = 4 \text{ mA}$		0.25	0.4		0.25	0.4	V
VOL	Low-level output voltage	V _I L = V _I Lmax,		$I_{OL} = 8 \text{ mA}$					0.35	0.5	v
lį	Input current at maximum input voltage	V _{CC} = MAX,	V _I = 7 V				0.1			0.1	mA
lіН	High-level input current	$V_{CC} = MAX$,	V _I = 2.7 V				20			20	μΑ
I _{IL}	Low-level input current	$V_{CC} = MAX$,	V _I = 0.4 V				-0.4			-0.4	mA
los	Short-circuit output current§	V _{CC} = MAX			-20		-100	-20		-100	mA
ICC	Supply current	$V_{CC} = MAX$,	See Note 2			17	27		17	27	mA

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

NOTE 2: With all outputs open and 4.5 V applied to all data and clear inputs, I_{CC} is measured after a momentary ground, then 4.5 V, is applied to clock.

switching characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
fmax	Maximum clock frequency	_	30	40		MHz
tPHL	Propagation delay time, high-to-low-level output from clear	$C_L = 15 \text{ pF},$ $R_1 = 2 \text{ k}\Omega,$		18	27	ns
tPLH	Propagation delay time, low-to-high-level output from clock	See Note 3		17	27	ns
tPHL	Propagation delay time, high-to-low-level output from clock			18	27	ns

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.



[‡] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.

[§] Not more than one output should be shorted at a time and duration of short circuit should not exceed one second.

PACKAGE MATERIALS INFORMATION

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TAPE AND REEL INFORMATION





A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74LS273DWR	SOIC	DW	20	2000	330.0	24.4	10.9	13.3	2.7	12.0	24.0	Q1
SN74LS273DWR	SOIC	DW	20	2000	330.0	24.4	10.8	13.3	2.7	12.0	24.0	Q1
SN74LS273NSR	SOP	NS	20	2000	330.0	24.4	8.4	13.0	2.5	12.0	24.0	Q1

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*All dimensions are nominal

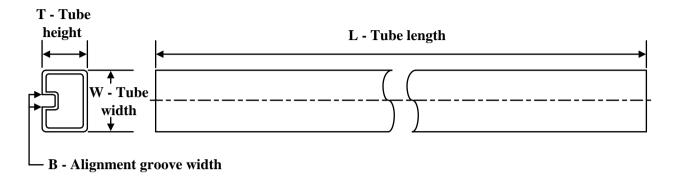
Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74LS273DWR	SOIC	DW	20	2000	367.0	367.0	45.0
SN74LS273DWR	SOIC	DW	20	2000	356.0	356.0	45.0
SN74LS273NSR	SOP	NS	20	2000	356.0	356.0	45.0





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TUBE



*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
78010012A	FK	LCCC	20	55	506.98	12.06	2030	NA
7801001SA	W	CFP	20	25	506.98	26.16	6220	NA
JM38510/32501B2A	FK	LCCC	20	55	506.98	12.06	2030	NA
JM38510/32501B2A.A	FK	LCCC	20	55	506.98	12.06	2030	NA
JM38510/32501BSA	W	CFP	20	25	506.98	26.16	6220	NA
JM38510/32501BSA.A	W	CFP	20	25	506.98	26.16	6220	NA
M38510/32501B2A	FK	LCCC	20	55	506.98	12.06	2030	NA
M38510/32501BSA	W	CFP	20	25	506.98	26.16	6220	NA
SN74LS273N	N	PDIP	20	20	506	13.97	11230	4.32
SN74LS273N.A	N	PDIP	20	20	506	13.97	11230	4.32
SN74LS273NE4	N	PDIP	20	20	506	13.97	11230	4.32
SNJ54LS273FK	FK	LCCC	20	55	506.98	12.06	2030	NA
SNJ54LS273FK.A	FK	LCCC	20	55	506.98	12.06	2030	NA
SNJ54LS273W	W	CFP	20	25	506.98	26.16	6220	NA
SNJ54LS273W.A	W	CFP	20	25	506.98	26.16	6220	NA

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